PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT2972194

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
SEONG-OOK JUNG	07/14/2014
YOUNGHWI YANG	07/14/2014
STANLEY SEUNGCHUL SONG	07/24/2014
CHOH FEI YEAP	08/05/2014
ZHONGZE WANG	07/24/2014

RECEIVING PARTY DATA

Name:	QUALCOMM INCORPORATED
Street Address:	5775 MOREHOUSE DRIVE
City:	SAN DIEGO
State/Country:	CALIFORNIA
Postal Code:	92121-1714

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14320024

CORRESPONDENCE DATA

Fax Number: (512)327-5575

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 512-327-5515

Email: dwade@tlgiplaw.com
Correspondent Name: TOLER LAW GROUP
Address Line 1: 8500 BLUFFSTONE COVE

Address Line 1. 0300 BEOTT OTONE

Address Line 2: SUITE A201

Address Line 4: AUSTIN, TEXAS 78759

ATTORNEY DOCKET NUMBER:	140014
NAME OF SUBMITTER:	DAVID WADE
SIGNATURE:	/David Wade/
DATE SIGNED:	08/07/2014

Total Attachments: 6

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ASSIGNMENT

WHEREAS, WE,

- 1. Scong-Ook JUNG, a citizen of the Republic of Korea, having a mailing address located at Engineering Bldg-2 725, 50 Yonsei-ro, Seodaemun-gu, Seoul 120-749, Korea and a resident of Seoul, Korea.
- Younghwi YANG, a citizen of the Republic of Korea, having a mailing address located at Engineering Bldg-2 725, 50 Yonsei-ro, Seodaemun-gu, Seoul 120-749, Korea and a resident of Seoul. Korea.
- 3. Stanley Seungchul SONG, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,
- 4. Choh Fei YEAP, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA,
- 5. Zhongze WANG, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA.

have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to **DUAL WRITE WORDLINE MEMORY CELL** (collectively the "**INVENTIONS**") for which WE have executed and/or may execute one or more patent applications therefor; and

WHEREAS, QUALCOMM Incorporated, a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A. and Industry-Academic Cooperation Foundation, Yonsei University, having a place of business at 134 Sinchon-dong, Seodaemun-gu, Seoul 120-749, Korea, (hereinafter "ASSIGNEE"), desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 14/320,024 filed June 30, 2014, Qualcomm

Reference No. 140014 and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States:

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions, Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof;

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument;

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance:

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries:

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at	Sexu KoreA,	n J <i>uly/14/2014</i>	Seong-Ook MING
	LOCATION	DATE	Scool-Ook MAG
Done at	<u> Georg Koria, .</u>	n <u>July/14/1</u> 04	Vounghwi YANG
	ECXATRON	2816	e consession a survivor
Done at	LOCATION . 0	n	Stanley Seungchul SONG
Done at	LOCATION , c	8	
	LOCATION	DATE	Choh Fei YEAP
Done at	LOCATION	n	Zhongze WANG

ASSIGNMENT

WHEREAS, WE.

- 1. Seong-Ook JUNG, a citizen of the Republic of Korea, having a mailing address located at Engineering Bidg-2 725, 50 Yousei-ro, Seodaemun-gu, Seoul 120-749, Korea and a resident of Seoul, Korea.
- 2. Younghwi YANG, a citizen of the Republic of Korea, having a mailing address located at Engineering Bldg-2 725, 50 Yonsei-ro, Seodaemun-gu, Seoul 120-749, Korea and a resident of Seoul, Korea,
- 3. Stanley Seungchul SONG, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA.
- 4. Choh Fei YEAP, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA.
- 5. Zhongze WANG, a citizen of the United States of America, having a mailing address located at 5775 Morehouse Drive, San Diego, CA 92121-1714 and a resident of San Diego, CA.

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WHEREAS, QUALCOMM Incorporated, a Delaware corporation, having a place of business at 5775 Morehouse Drive, San Diego, California 92121-1714, U.S.A. and Industry-Academic Cooperation Foundation, Yonsei University, having a place of business at 134 Sinchon-dong, Seodaemun-gu, Seoul 120-749, Korea, (hereinafter "ASSIGNEE"), desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all inventions related thereto or thereof, all patent applications therefor, and all patents that have granted or may be granted hereafter thereon, including but not limited to those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged. WE do hereby acknowledge that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefor that may have been filled or may be filled hereafter for said INVENTIONS in the United States, including but not limited to U.S. Application No. 14/320,024 filled June 30, 2014, Qualcomm

Reference No. 140014 and all provisional applications relating thereto, (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known), and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, and design applications thereof, and all issued patents of the United States which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon in the United States:

AND WE further do acknowledge and agree that WE have sold, assigned, conveyed, and transferred, and by these presents do hereby sell, assign, convey, and transfer, unto ASSIGNEE, its successors, its legal representatives, and its assigns, all rights of priority under International Conventions. Treaties, or Agreements, and the entire right, title, and interest throughout the world in said INVENTIONS, including all inventions related thereto or thereof, and all patent applications therefor that may have been filed or may be filed hereafter for said INVENTIONS in any foreign country, countries, or treaty/union organizations, and all divisional applications, renewal applications, continuation applications, continuation-in-part applications, patent of addition applications, confirmation applications, validation applications, utility model applications, and design applications thereof, and all issued patents which may have granted or may be granted hereafter for said INVENTIONS in any country or countries foreign to the United States, and all reissues, renewals, reexaminations, and extensions thereof.

AND WE DO HEREBY authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to said ASSIGNEE, its successors, its legal representatives and its assigns, in accordance with the terms of this instrument:

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover, and retain damages and any ongoing or prospective royalties to which WE may be entitled, or that WE may collect for any infringement or from any settlement or agreement related to any of said patents before or after issuance:

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries:

AND WE HEREBY covenant that WE will not execute any writing or do any act whatsoever conflicting with these presents.

Done at		on	
~~******************\	LOCATION	DATE	Seong-Ook JUNG
Done at	LOCATION	_, on	Younghwi YANG
Done at	LOCATION LOCATION	on <u>7/24/14</u> DATE	Stanley Seungebul SONG
Done at	San Dega LOCATION	., on <u>6/5//</u> DATE	Choh Fei YEAP
Done at _	ZZAK DISCO	on 7/24/22/1	Zhongze WANG

PATENT REEL: 033485 FRAME: 0112

RECORDED: 08/07/2014